Product data sheet

1. General description

NPN medium power transistor series encapsulated in an ultra thin DFN2020D-3 (SOT1061D) leadless small Surface-Mounted Device (SMD) plastic package with medium power capability and visible and solderable side pads.

2. Features and benefits

- High collector current capability I_C and I_{CM}
- Reduced Printed-Circuit Board (PCB) area requirements
- · Exposed heat sink for excellent thermal and electrical conductivity
- · Two current gain selections
- Leadless very small SMD plastic package with medium power capability
- · Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified

3. Applications

- · Linear voltage regulators
- · Battery driven devices
- MOSFET drivers
- · High-side switches
- Power management
- · Amplifiers

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base		-	-	80	V
I _C	collector current			-	-	1	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	2	Α
h _{FE}	DC current gain						'
	BC56PAS	V _{CE} = 2 V; I _C = 150 mA; T _{amb} = 25 °C	[1]	63	-	250	
	BC56-10PAS	1	[1]	63	-	160	
	BC56-16PAS		[1]	100	-	250	

[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	В	base	3	
2	Е	emitter		С
3	С	collector	Transparent top view DFN2020D-3 (SOT1061D)	B — E sym021

6. Ordering information

Table 3. Ordering information

Table of Ordering Information							
Type number	Package						
	Name	Description	Version				
BC56PAS	DFN2020D-3	plastic, leadless thermal enhanced ultra thin small outline	SOT1061D				
BC56-10PAS		package with side-wettable flanks (SWF); no leads; 3 terminals; 1.3 mm pitch; 2 mm x 2 mm x 0.65 mm body					
BC56-16PAS		Commander, 1.5 min piton, 2 min x 2 min x 0.05 min body					

7. Marking

Table 4. Marking codes

Type number	Marking code
BC56PAS	CK
BC56-10PAS	CL
BC56-16PAS	CM

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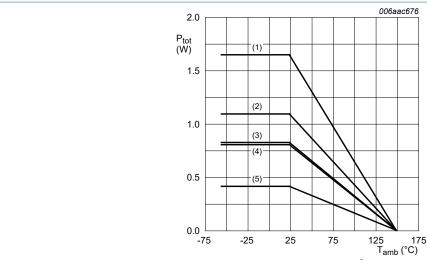
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	100	V
V _{CEO}	collector-emitter voltage	open base		-	80	V
V _{EBO}	emitter-base voltage	open collector		-	5	V
Ic	collector current			-	1	Α
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	2	А
I _B	base current			-	0.3	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	0.42	W
			[2]	-	0.81	W
			[3]	-	0.83	W
			[4]	-	1.10	W
			[5]	-	1.65	W
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 1 cm². Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm². Device mounted on an FR4 PCB, 4-layer copper, tin-plated and mounting pad for collector 1 cm². [3]
- [5]



- (1) FR4 PCB, 4-layer copper, mounting pad for collector 1 cm²
- (2) FR4 PCB, single-sided copper, mounting pad for collector 6 cm²
- (3) FR4 PCB, single-sided copper, mounting pad for collector 1 cm²
- (4) FR4 PCB, 4-layer copper, standard footprint
- (5) FR4 PCB, single-sided copper, standard footprint

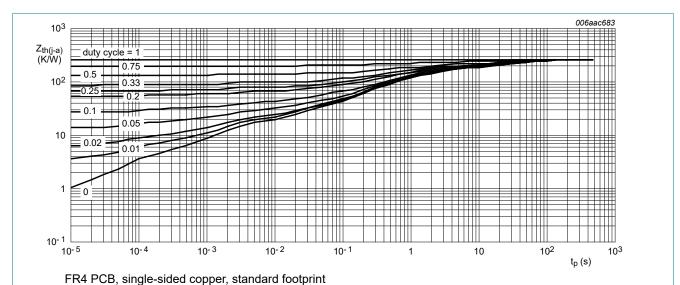
Fig. 1. **Power derating curves**

9. Thermal characteristics

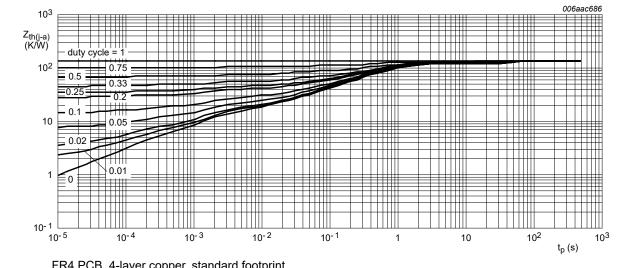
Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	[1] [2] [3] [4] [5]	[1]	-	-	298	K/W
	junction to ambient		[2]	-	-	154	K/W
			[3]	-	-	151	K/W
			[4]	-	-	114	K/W
			-	-	76	K/W	
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	20	K/W

- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 1 cm²
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².
- Device mounted on an FR4 PCB, 4-layer copper, tin-plated and mounting pad for collector 1 cm².



Transient thermal impedance from junction to ambient as a function of pulse duration; typical values Fig. 2.



FR4 PCB, 4-layer copper, standard footprint

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

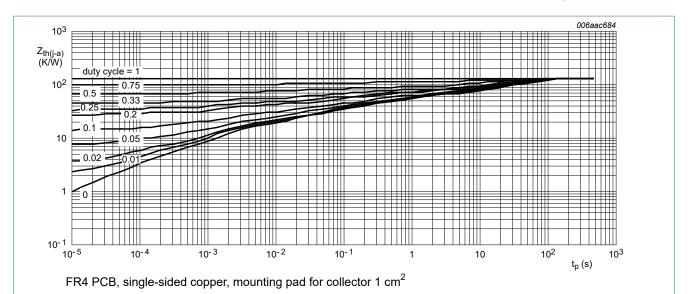
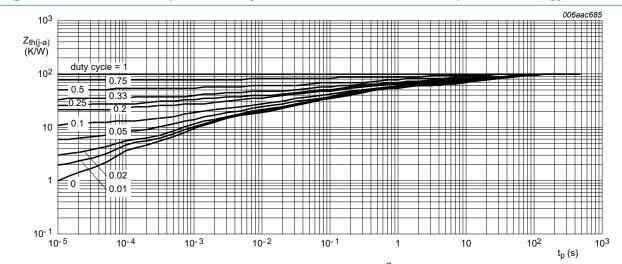
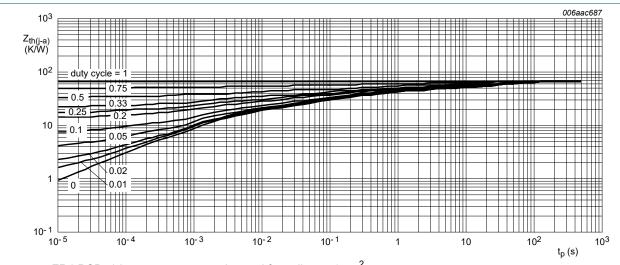


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, single-sided copper, mounting pad for collector 6 cm²

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, mounting pad for collector 1 cm²

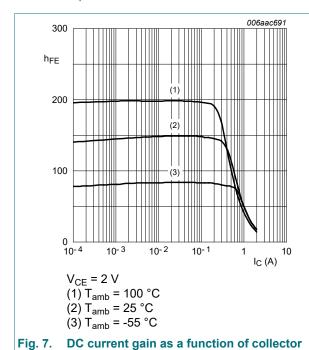
Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	V _{CB} = 30 V; I _E = 0 A; T _{amb} = 25 °C		-	-	100	nA
	current (emitter open)	V _{CB} = 30 V; I _E = 0 A; T _{amb} = 150 °C		-	-	10	μΑ
I _{EBO}	emitter-base cut-off current (collector open)	V _{EB} = 5 V; I _C = 0 A; T _{amb} = 25 °C		-	-	100	nA
h _{FE}	DC current gain					<u> </u>	
	BC56PAS	V _{CE} = 2 V; I _C = 5 mA; T _{amb} = 25 °C		63	-	-	
	BC56-10PAS			63	-	-	
	BC56-16PAS			63	-	-	
	BC56PAS	V _{CE} = 2 V; I _C = 150 mA; T _{amb} = 25 °C		63	-	250	
	BC56-10PAS			63	-	160	
	BC56-16PAS			100	-	250	
	BC56PAS	V _{CE} = 2 V; I _C = 500 mA; T _{amb} = 25 °C		40	-	-	
	BC56-10PAS			40	-	-	
	BC56-16PAS			40	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ °C}$	[1]	-	-	500	mV
V _{BE}	base-emitter voltage	V _{CE} = 2 V; I _C = 500 mA; T _{amb} = 25 °C	[1]	-	-	1	V
C _c	collector capacitance	V_{CB} = 10 V; i_e = 0 A; f = 1 MHz; T_{amb} = 25 °C		-	6	-	pF
f _T	transition frequency	V_{CE} = 5 V; I_{C} = 50 mA; f = 100 MHz; T_{amb} = 25 °C		100	180	-	MHz

[1] pulsed; $t_p \le 300 \ \mu s; \ \delta \le 0.02$



current; typical values

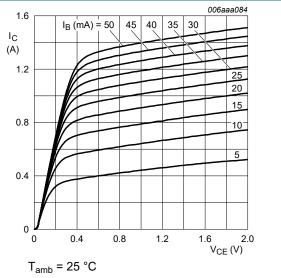


Fig. 8. Collector current as a function of collectoremitter voltage; typical values

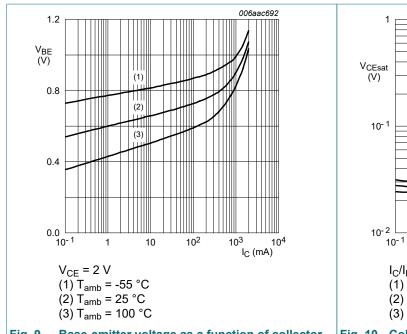


Fig. 9. Base-emitter voltage as a function of collector current; typical values

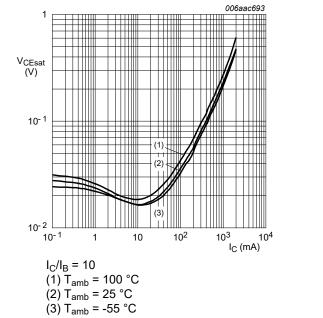


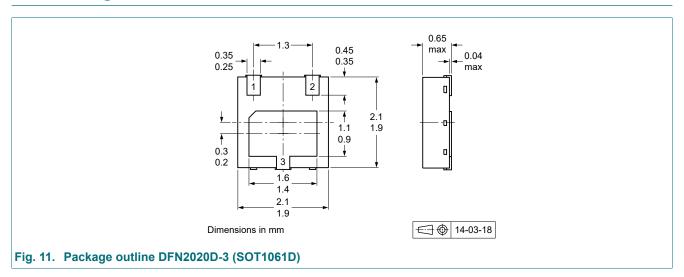
Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

11. Test information

11.1. Quality information

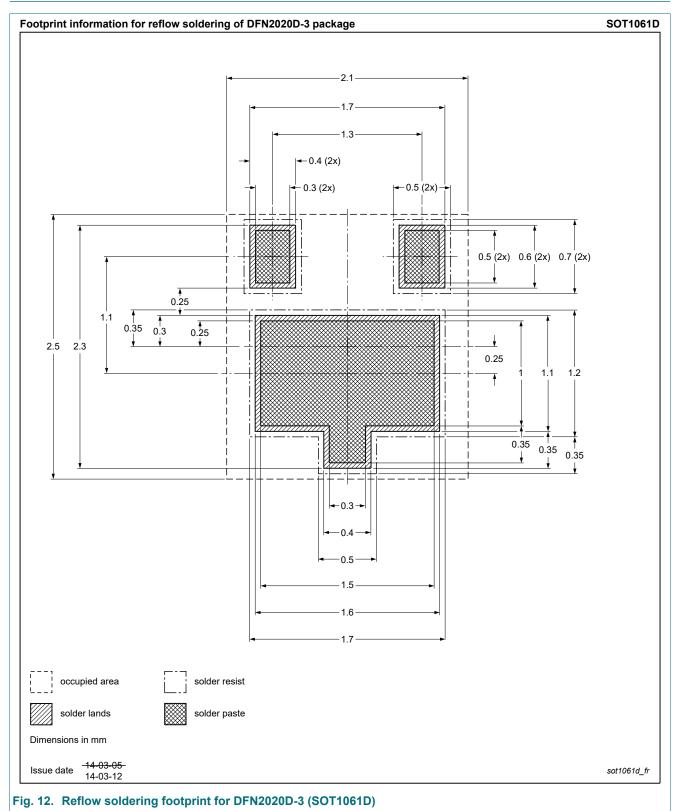
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



14. Revision history

Table 8. Revision history

Tubio of Itovioloff filotory				
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BC56XPAS_SER v.2	20230502	Product data sheet	-	BC54_55_56PAS_SER v.1
Modifications:	 Family data st 	neet splitted to three	data sheets	
BC54_55_56PAS_SER v.1	20141111	Product data sheet	-	-

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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